

Product Description

The BSW7221V/BSW7221VT is a reflective SPDT RF switch that can be used in high power and good performance for Automotive, WLAN 802.11 a/b/g/n/ac/ax/be Networks, Ultra-Wide-Band (UWB) and Wireless Communication applications.

The BSW7221V/BSW7221VT is packaged in RoHS2-compliant with 1.5mm x 1.5mm x 0.5mm, 6-Lead UDFN package. It must be used with back side ground soldering.

The BSW7221V/BSW7221VT has robust ESD protection circuits at all pins and temperature performance. (Operating temperature range : -40 to +105°C)

The BSW7221V/BSW7221VT does not require blocking capacitors. If DC is presented at the RF port, add a blocking capacitor. The BSW7221V/BSW7221VT also has a high linearity performance over all temperature range such as IIP3, IIP2. AEC-Q100 Grade 2 was qualified.

Block Diagram

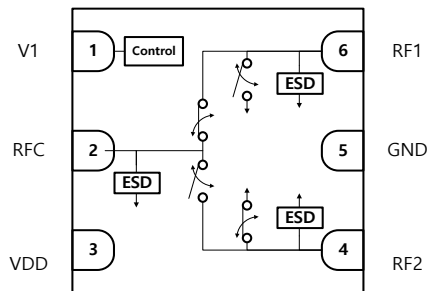
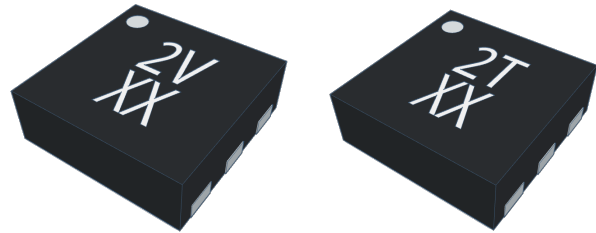


Figure 1. Functional Block Diagram

Applications

- Automotive
- WLAN 802.11 a/b/g/n/ac/ax/be
- Ultra-Wide-Band (UWB)
- Vehicle to Everything(V2X)
- Remote keyless entry
- Telematics / Infotainment
- GPS/Navigation
- Wireless control systems

Package Type



1.5mm x 1.5mm x 0.5mm, 6-Lead UDFN Package

Figure 2. Package Type

Device Features

- AEC-Q100 Grade 2 Qualified and PPAP capable
- Operating Frequency range : 5 MHz to 8.5 GHz
- Fast Switching Time : 90 to 135 ns
- Supply Voltage : 2.7V to 3.6V
- Low insertion loss
 - : 0.37dB @ 2.45GHz
 - : 0.59dB @ 5.75GHz
- High isolation
 - : 44dB @ 2.45GHz
 - : 29dB @ 5.75GHz
- Input 1 dB output compression
 - : 37dBm @ 2.45GHz
 - : 35dBm @ 5.75GHz
 - : 34dBm @ 8.00GHz
- High IIP3
 - : 65dBm @ 2.45GHz
 - : 62dBm @ 5.75GHz
- ESD protection
 - : HBM 2.0kV
 - : CDM 1.0kV
- 6-Lead UDFN package : 1.5mm x 1.5mm x 0.5mm
- Operating temperature range : -40°C to +105°C
- Lead-free/RoHS2-compliant UDFN package

Ordering Information

Part Number	Descriptions
BSW7221V	Mass Test in RT(+25°C)
BSW7221VT	Mass Test in LT(-40°C) / RT(+25°C) / HT(+105°C)
BSW7221V-EVB BSW7221VT-EVB	BSW7221V / BSW7221VT Evaluation Board

Electrical Specifications

VDD = 3.3V, T_A = 25°C, V1 Low = 0V, V1 High = 3.3V, Z_L = 50Ω, Excluding SMA Connector and PCB loss⁽¹⁾, unless otherwise noted.

Table 1. Electrical Specifications

Parameter	Path	Condition	Min	Typ	Max	Unit
Operating Frequency			5		8500	MHz
Insertion Loss	RFC - RFx	13.56MHz 1GHz 2GHz 3GHz 4GHz 5GHz 6GHz 7GHz 8GHz 8.5GHz		0.29 0.32 0.36 0.38 0.42 0.47 0.61 0.53 0.57 0.81		dB
Isolation	RFC - RFx	13.56MHz 1GHz 2GHz 3GHz 4GHz 5GHz 6GHz 7GHz 8GHz 8.5GHz		83 52 47 39 34 31 30 27 24 23		dB
Isolation	RFx - RFx	13.56MHz 1GHz 2GHz 3GHz 4GHz 5GHz 6GHz 7GHz 8GHz 8.5GHz		79 45 36 33 30 28 25 23 21 20		dB
Return Loss	RFC, RF1, RF2	5MHz – 8.5GHz (Active port)		20		dB

(1) Excluding SMA Connector and PCB loss.

1GHz (0.15dB), 2GHz (0.23dB), 3GHz (0.31dB), 4GHz (0.39dB), 5GHz (0.45dB), 6GHz (0.53dB), 7GHz (0.67dB), 8GHz (0.73dB)

Electrical Specifications

VDD = 3.3V, T_A = 25°C, V1 Low = 0V, V1 High = 3.3V, Z_L = 50Ω, Excluding SMA Connector and PCB loss⁽¹⁾, unless otherwise noted.

Table 2 Electrical Specifications

Parameter	Path	Condition	Min	Typ	Max	Unit
Operating Frequency			5		8500	MHz
Input P1dB	RFC - RFx	13.56MHz 2.45GHz 5.75GHz 8.00GHz		33 37 35 34		dBm
Input IP3 ⁽²⁾	RFC - RFx	2.45GHz 5.75GHz		65 62		dBm
Input IP2 ⁽²⁾	RFC - RFx	2.45GHz 5.75GHz		110 90		dBm
2 nd Harmonic ⁽³⁾	RFC - RFx	2.45GHz 5.75GHz		95 75		dBc
3 rd Harmonic ⁽³⁾	RFC - RFx	2.45GHz 5.75GHz		100 95		dBc
Switching Time	RFC - RFx	50% control to 90% RF 50% control to 10% RF		135 90		ns
Settling Time	RFC - RFx	50% CTRL to 0.05dB final value Rising Edge 50% CTRL to 0.05dB final value Falling Edge		145 110		ns
Maximum Spurious Level	RFC - RFx	50MHz - 500MHz 500MHz - 800MHz > 800MHz ⁽⁴⁾		-120 -135 <-145		dBm/10Hz

(1) Excluding SMA Connector and PCB loss.

1GHz (0.15dB), 2GHz (0.23dB), 3GHz (0.31dB), 4GHz (0.39dB), 5GHz (0.45dB), 6GHz (0.53dB), 7GHz (0.67dB), 8GHz (0.73dB)

(2) The two-tone Power is 18dBm each and Tone spacing is 20KHz.

(3) The two-tone Power is 18dBm each.

(4) No spurious signals were detected above 800MHz.

Pin Configurations

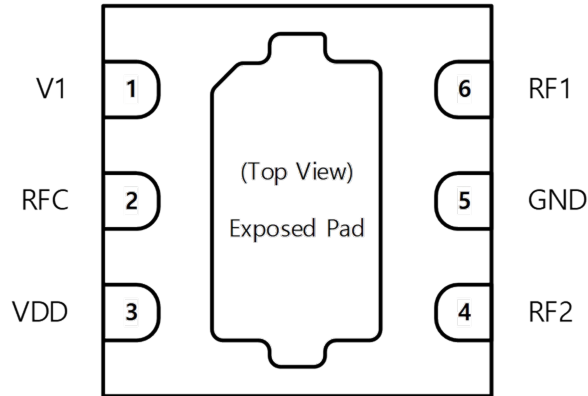


Figure 3 . Pin Configurations (Top View)

Table 3. Pin Descriptions

No.	Pin Name	Descriptions
1	V1	Digital Control Logic Input
2	RFC	RF Common port
3	VDD	Supply Voltage
4	RF2	RF2 port
5	GND	Ground
6	RF1	RF1 port
Pad	Exposed Pad	Ground

Table 4. V1 Control Truth Table

V1	RFC-RF1	RFC-RF2
0	OFF	ON
1	ON	OFF

Table 5. Recommended Operation Conditions⁽¹⁾

Parameter	Symbol	Min	Typ	Max	Unit
Supply Voltage	VDD	2.7	3.3	3.6	V
Supply Current	IDD	-	170	350	μA
Digital Input Control (V1)	V1 High	1.0	-	3.3	V
	V1 Low	0	-	0.7	V
Operating Temperature Range	To	-40	+25	+105	°C
RF Input Power, CW Freq.=2.45GHz, 5.75GHz any port, Z _L =50Ω	-	-	-	30	dBm

(1) Specifications are not guaranteed over all recommended operating conditions.

Table 6. Absolute Maximum Ratings

Parameter			Symbol	Min	Max	Unit
Supply Voltage			VDD	-0.3	3.6	V
Digital Input Voltage (V1)			V1	-0.3	3.6	V
Maximum Input Power, CW (+25°C)			-	-	Input P1dB	dBm
Storage Temperature range			-	-65	+150	°C
Maximum Junction Temperature			-	-	+150	°C
ESD	HBM	All pins	-	-	2000	V
	CDM	All pins	-	-	1000	V

Table 7. Package Thermal Characteristics

Parameter		Symbol	Value	Unit
Junction to Ambient Thermal Resistance		θ_{JA}	80	°C/W
Junction to Case Thermal Resistance (Heatsink applied to Package Bottom)		θ_{JC}	5	°C/W

Typical Performances

VDD = 3.3V, $T_A = 25^\circ\text{C}$, V1 Low = 0V, V1 High = 3.3V, $Z_L = 50\Omega$, Excluding SMA Connector and PCB loss, unless otherwise noted.

Figure 4. Insertion Loss vs. Vdd (RFC - RFx)

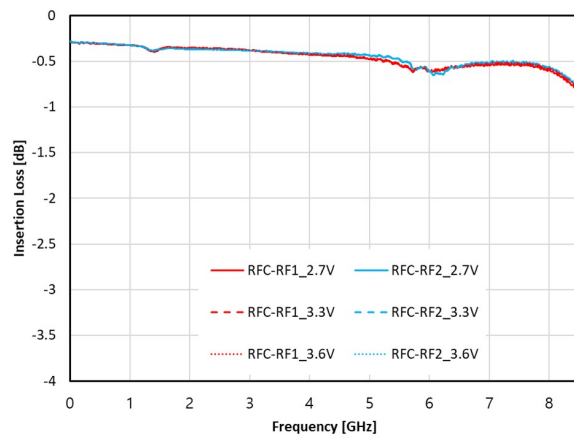


Figure 5. Insertion Loss vs. Temp (RFC - RFx)

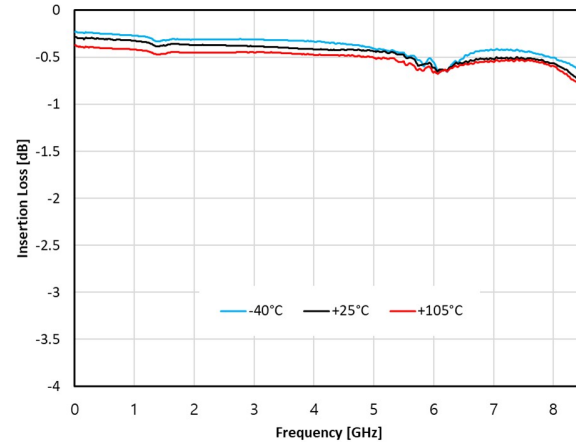


Figure 6. Return Loss (RFC, RFx)

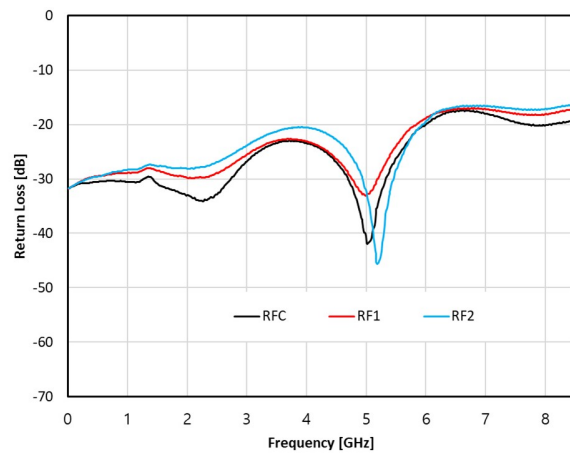
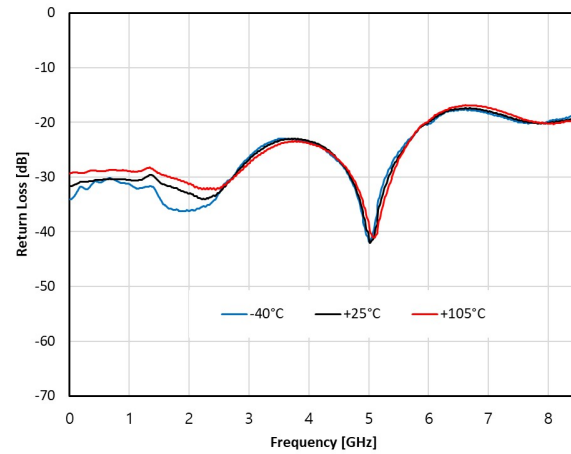


Figure 7. Return Loss vs. Temp (RFC)



Typical Performances

VDD = 3.3V, $T_A = 25^\circ\text{C}$, V1 Low = 0V, V1 High = 3.3V, $Z_L = 50\Omega$, Excluding SMA Connector and PCB loss, unless otherwise noted.

Figure 8. Isolation vs. Vdd (RFC - RFx)

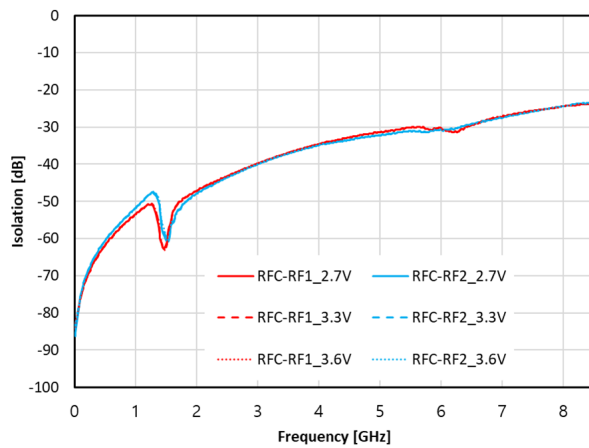


Figure 9. Isolation vs. Temp (RFC - RFx)

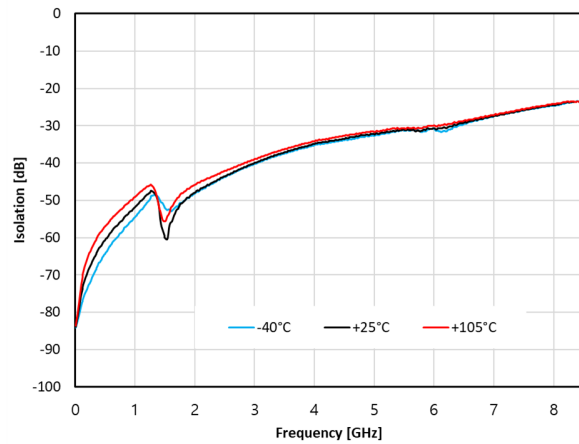


Figure 10. Isolation vs. Vdd (RFx - RFx)

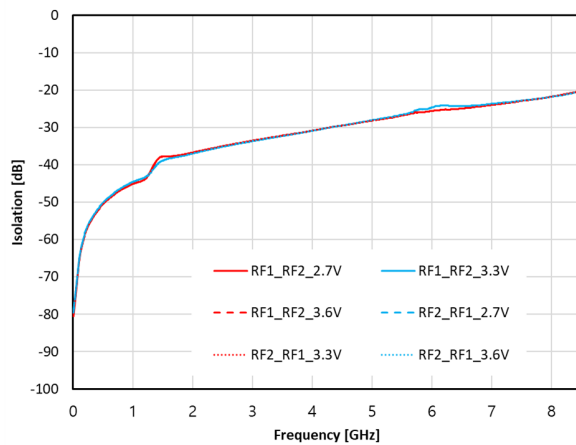
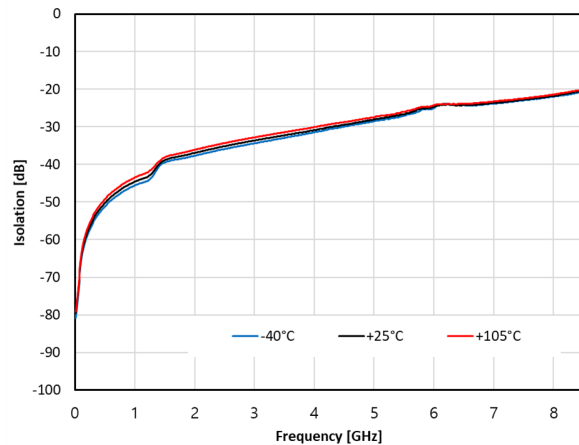


Figure 11. Isolation vs. Temp (RFx - RFx)



Evaluation Board

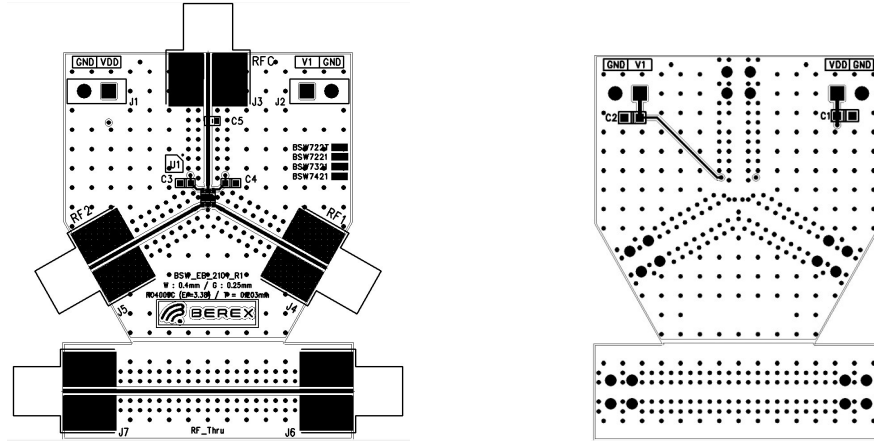


Figure 12. Evaluation Board Layout

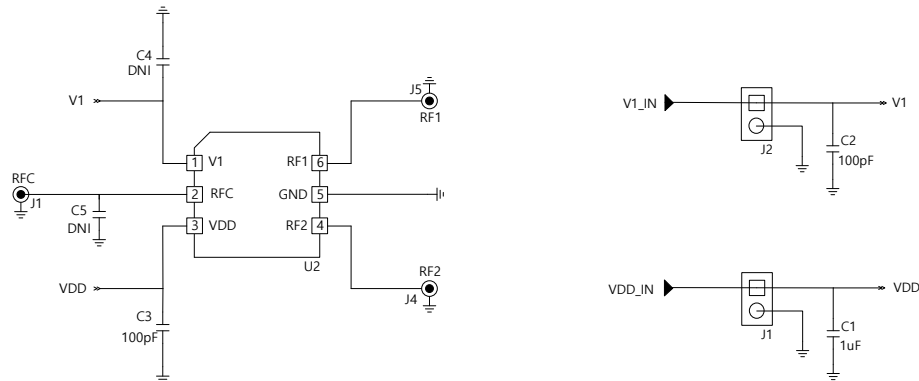


Figure 13. Evaluation Board Schematic

RO4003C Er : 3.38	COPPER : 1oz (0.035mm), Top Layer	FINISH THICKNESS : 1.63T
	RO4003C / 0.2mm	
FR-4 Er : 4.5~4.8	COPPER : 1oz (0.035mm), Inner 1 Layer	
	FR-4 / 0.36mm	
FR-4 Er : 4.5~4.8	COPPER : 1oz (0.035mm), Inner 2 Layer	
	FR-4 / 0.93mm	
	COPPER : 1oz (0.035mm), Bottom Layer	

Figure 14. Evaluation Board PCB Layer Information

No.	Ref Des	Part Qty	Part Number	Remark
1	C1	1	CAP 1005 1uF J 50V	
2	C2,C3 ⁽¹⁾	2	CAP 1005 100pF J 50V	
3	C4	2	CAP 1005 DNI	
4	C5	1	CAP 0603 DNI	
6	J1,J2	2	2 Pin Header	
7	RFC, RF1, RF2	3	SMA_END_LAUNCH	Female
8	U1	1	BSW7221V/BSW7221VT	

(1) C3 should be placed near the device.

Table 8. Bill of Material - Evaluation Board

Package Outline Drawing

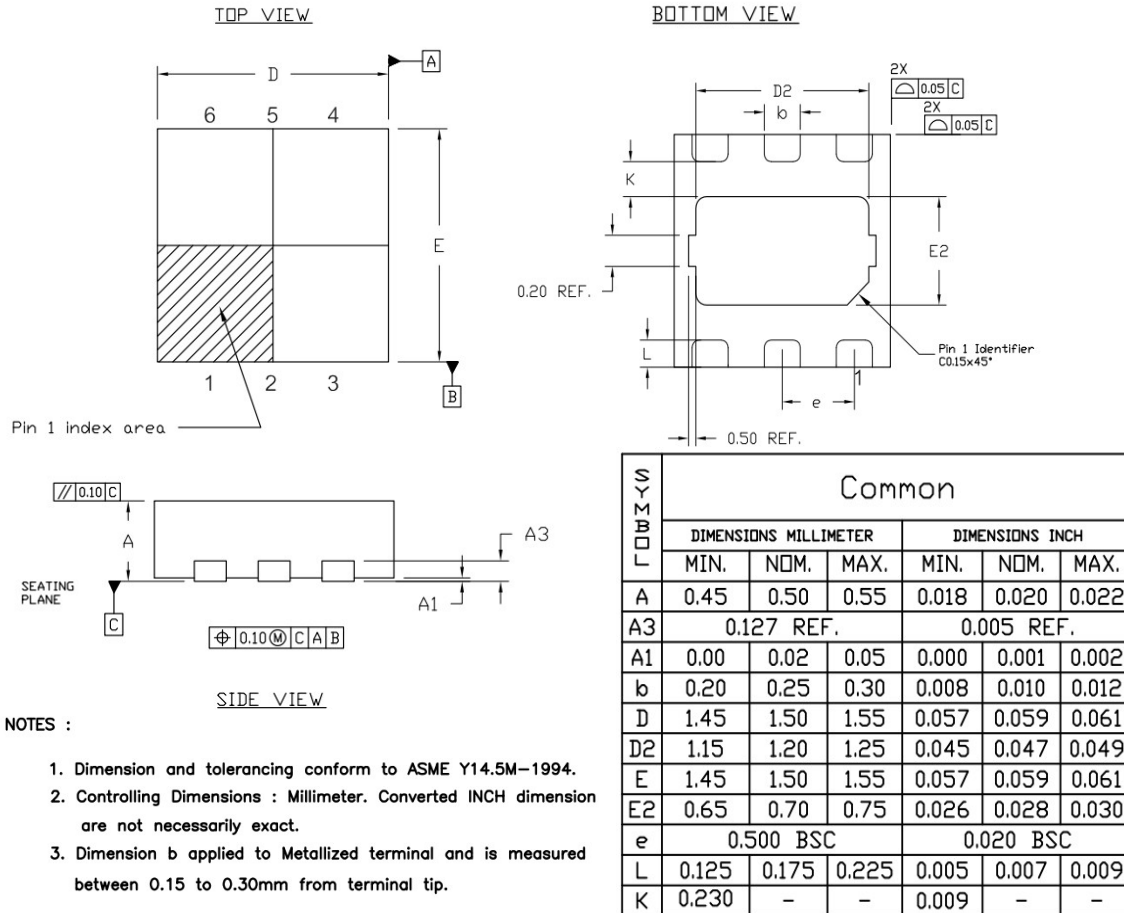


Figure 15. Package Outline Drawing

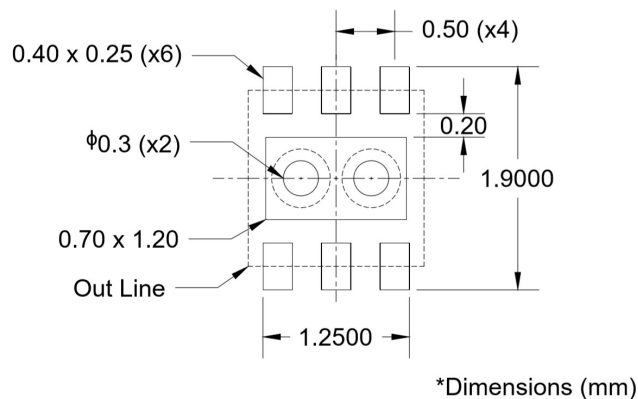
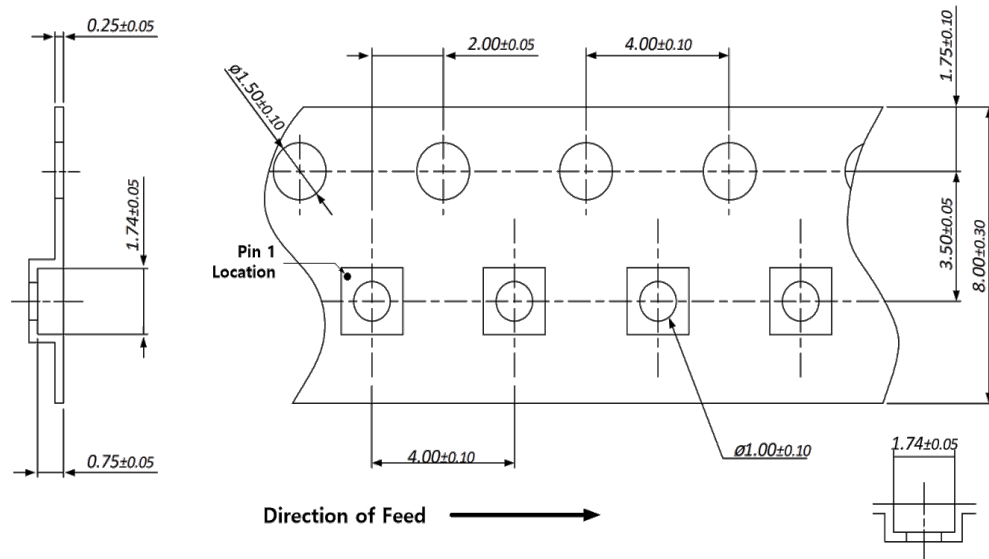


Figure 16. Recommended Land Pattern

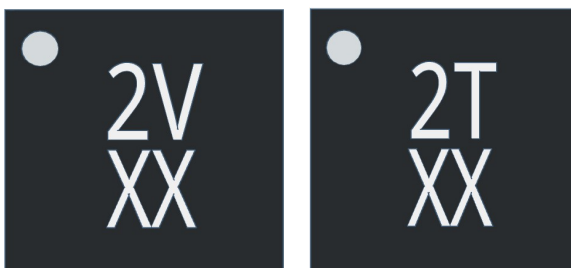
Tape & Reel



Packaging information:	
Tape Width	8mm
Reel Size	7inch
Device Cavity Pitch	4mm
Device Per Reel	3000EA

Figure 17. Tape & Reel

Package Marking



Marking information:	
Marking Code	
2	The number of switch throw
V or T	Sequential Number
XX	Wafer Lot Number

Figure 18. Package Marking

Lead plating finish

100% Tin Matte finish

(All BeRex products undergoes a 1 hour, 150 degree C, Anneal bake to eliminate thin whisker growth concerns.)

MSL / ESD Rating

ESD information:	
Rating	Class 2 (2000V)
Test	Human Body Model (HBM)
Standard	AEC-Q100-002

ESD information:	
Rating	Class C3 (1000V)
Test	Charged Device Model (CDM)
Standard	AEC-Q100-011

MSL information:	
Rating	Level 1 at +260°C convection reflow
Standard	JEDEC Standard J-STD-020



Proper ESD procedures should be followed when handling the device.

RoHS2 Compliance

This part is compliant with Restrictions on the use of certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) Directive 2011/65/EU as amended by Directive 2015/863/EU.

This product also is compliant with a concentration of the Substances of Very High Concern (SVHC) candidate list which are contained in a quantity of less than 0.1%(w/w) in each components of a product and/or its packaging placed on the European Community market by the BeRex and Suppliers.

NATO CAGE code:

2	N	9	6	F
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